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(54) Title: SEMICONDUCTOR WAFER HUBBED SAW BLADE AND PROCESS FOR MANUFACTURE THEREOF

(57) Abstract

In a plating process for constructing a nickel embedded abrading particle saw blade on a saw blade substrate, the step of plating abrading particles onto and within the supporting copper substrate is disclosed. The beveled edge of a circular aluminum saw blade blank (20) is first coated with a thin zinc layer (24). Thereafter, copper (26) and abrading particles (36) are plated followed by conventional abrading particle and nickel plating. Conventional material removal thereafter follows at the saw blade side adjacent the circular saw blade blank (20), saw blade edge (22), and copper layer (26). The final saw blade product produced has uniform cutting edges on both sides with less likelihood of producing edge fractures, chips, or cracks in silicon wafers during separation.

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"SEMICONDUCTOR WAFER HUBBED SAW BLADE AND PROCESS FOR MANUFACTURE THEREOF"

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This invention relates to an improved semiconductor wafer hubbed saw blade. More particularly an improved saw blade and process for the manufacture of the saw blade is disclosed which results in a hubbed saw blade product produced without the requirement for electro-polishing to expose abrading particles, such as diamonds, in one of the saw blade edges.

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BACKGROUND OF THE INVENTION

The fabrication of saw blades for cutting silicon substrates to separate produced integrated circuits one from another is a multi-step plating process adhering to the periphery of an aluminum saw blade blank. In the understanding of the invention that is set forth hereafter, it is necessary to carefully understand the prior art.

In the following description of the prior art, faults of the prior art will be identified with specificity. The reader will understand that invention is claimed in the discovery of these faults. It goes without saying that the discovery of the problem to be solved is part of the invention claimed herein.

Referring to Fig. 8, the invention herein relates to the fabrication of saw blade S having sufficient hardness to cut the silicon substrate T on which circuits are printed. (See Figs. 12A and 12B). A description of silicon substrate T will be first given followed by the details of prior art saw blade manufacture.

Referring to Figs. 12 A and 12B, silicon substrate T is illustrated having a plurality of electrical leads 14 imprinted thereon. Saw blade kerf K is illustrated cutting to

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electrical leads 14. In Fig. 12B, a desired saw blade kerf K is illustrated. The reader will observe that at edges 16 of saw blade kerf K, no visible cracking or shearing at the kerf edges 16 has occurred on silicon substrate T.

This situation is to be distinguished from the condition of saw blade kerf K illustrated in Fig. 12A. It will be observed that edge chipping, cracks, or fractures 18 are present on one side of edges 16. These cracks, chips, or fractures are analogous to splinters produced by wood saws on paneling where there is a defect of the saw. Here, however, such cracks, chips, or fractures interfere with the integrity of the produced circuit. Specifically, edge fractures 18 can interfere with the integrity of chips on the substrate that are ultimately separated. It will be seen that edge fractures 18 penetrate electrical leads 14. When it is remembered that ultimately produced integrated circuits sometimes have hundreds of such leads, and that a single crack 18 disrupting a single lead 14 can render an entire chip defective, edge fractures 18 pose a serious threat to chip process yield.

It now is useful to trace the prior art production of saw blades S for an understanding of those defects which can lead to edge fractures 18. Returning to Fig. 8, it will be seen circular aluminum saw blade hub 20 is provided with beveled edge 22. Circular aluminum saw blade hub 20 has a central aperture for attachment to a saw arbor. As will hereafter be set forth, it includes beveled edge 22 which when fully processed holds nickel embedded abrading particle saw blade edge 80. It is the sequence of this abrading particle embedding that is altered to attain the process and article of manufacture of this invention.

It is important to realize that in the preferred case, diamonds will be the imbedded abrading particle. However, other abrading particles may as well be used. For example, other abrasive particles such as aluminum oxide, silicon carbide, or abrasive materials such as titanium may be used.

Accordingly, Figs. 1A - 1F are all sections taken along section 1 - 1 of Fig. 8 during various plating, etching

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and electro-polishing steps required to produce the saw blades. Such plating, etching and electro-polishing usually occurs when a plurality of saw blades S are mounted to a mandrel M (See Fig. 7) and electro-plated, etched or polished in processing vats V as illustrated in Figs. 9 and 10.

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The reader will understand that we only illustrate our plating vats having improvements. However, since such plating, etching and electro-polishing is well understood in the prior art, further illustration will not be included herein.

Referring to the illustration of the prior art sequence shown in Figs. 1A - 1F, the fabrication of saw blade S can be understood.

Referring to Fig. 1A, beveled edge 22 is dipped

first in electrode less zinc plating solution to deposit thin
zinc layer 24. Zinc layer 24 has the property of adhering to
the aluminum of saw blade S while presenting a substrate to
which first copper and then nickel can be plated.

Continuing on with Fig. 1A, after placing of a thin zinc layer 24, copper layer 26 is added to beveled edge 22 over the zinc. There results the cross-section of Fig. 1A.

Referring to Fig. 1B, nickel embedded abrading particle layer 28 is plated to beveled edge 22 over copper layer 26 and zinc layer 24. Such plating occurs by placing abrading particles of the desired size -- for example 4 to 6 microns -- in a nickel plating solution such as that illustrated in Figs. 9 and 10. Thereafter, and once plating has begun, the abrading particles are moved into suspension -- typically by periodically bubbling air through the plating tank having abrading particles in the path of the air bubbles. The abrading particles are then moved into suspension -- and thereafter gradually settle during the plating process. Some abrading particles are attracted to and become embedded in nickel being plated. This results in the configuration shown in Fig. 1B.

At this stage, all surfaces necessary for the production of saw blade S are plated. What remains is to remove and expose the plated abrading particles for cutting.

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Referring to Fig. 1C, etching of the plated material from beveled edge 22 has occurred. This exposes one side of circular aluminum saw blade hub 20 for direct machining. Similarly, and referring to Fig. 1D, grinding of material from end edge 30 occurs.

Referring to Fig. 1E, then machining of beveled edge 22 occurs to leave an approximate five mil layer 32. Thereafter, and to reach the configuration of Fig. 1F, five mil layer 32 is chemically removed.

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DISCOVERY OF THE PROBLEM

In the analysis of the prior art that led to this invention, it was required to generate a detailed understanding of the prior art. It is therefore useful to understand in detail, the cross-section 2 - 2 of Fig. 1F.

Referring to Fig. 2A, after removal of five mil layer 32 of aluminum of saw blade S, it will be seen that copper layer 26 is still intact. Further, the configuration of nickel embedded abrading particle layer 28 is instructive. Specifically, all abrading particles 36 are imbedded up to -but never into -- copper layer 26. When copper layer 26 is removed -- either chemically or by garnating -- abrading particles 36 will be embedded in the nickel of embedded abrading particle layer 28. These abrading particles 36 will never protrude from nickel embedded abrading particle layer This embedding of abrading particles 36 is not unlike the 28. embedding of aggregate in a concrete form adjacent the walls of the form. Specifically, the abrading particles may have and an edge adjacent the interface between the nickel and copper -- but will never protrude from that interface. copper side interface 40 is designated in Figs. 1F and 2A.

Opposite or plated interface 42 is different. Specifically, and during the plating process, abrading particles 36 fastened to nickel embedded abrading particle layer 28 so as to surface expose at least some of abrading particles 36.

It is known that if the blade configuration of Fig. 2A were to be used for cutting, exposing of abrading particles

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36 is required. In order to achieve the required exposure of abrading particles 36 on copper side interface 40, electropolishing is utilized. Specifically, the plating anode/cathode relationship is reversed for a period of time sufficient to remove nickel and expose abrading particles 36 from nickel embedded abrading particle layer 28 at copper side interface 40. In the prior art fabrication, this step is individually accomplished for each saw blade S.

While this treatment is beneficial for copper side interface 40, it is detrimental to plated interface 42. Metal when removed from plated interface 42 leaves surface exposed abrading particles 36' after the plating. These surface exposed abrading particles 36' can be directly traced to edge fractures 18 in saw blade kerf K. It is this realization which has resulted in the process and article of manufacture of this invention.

In the prior art method of manufacture, the step of electro-polishing is a critical step. Each saw blade is usually individually electro-polished. Further, either insufficient electro-polishing or too much electro-polishing can cause quality control rejection of the produced saw blade. When it is remembered that this rejection occurs at the very end of the saw blade production process, it can be understood that such rejection is expensive -- occurring when the saw blade is almost completely finished.

SUMMARY OF THE INVENTION

In a plating process for constructing a nickel embedded abrading particle saw blade on a saw blade substrate, the step of plating abrading particles onto and within the supporting copper substrate is disclosed. The beveled edge of a circular aluminum saw blade blank is first coated with a thin zinc layer. Thereafter, copper and abrading particles are plated followed by conventional abrading particle and nickel plating. Conventional material removal thereafter follows at the saw blade side adjacent the circular saw blade blank, saw blade edge, and copper layer. With removal of the copper layer, abrading particles originally partially embedded

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in the copper layer are exposed for cutting. The need for electro-polishing and garnating is eliminated in so far as exposure of abrading particles is concerned. The final saw blade product produced has uniform cutting edges on both sides with less likelihood of producing edge fractures, chips, or cracks in silicon wafers during separation. Improvements in the overall processing of the chip are disclosed including the use of circular electrodes, a reshaped plating basket having a conical bottom, a band of central perforations, and the use of a weak cobalt/nickel alloy to bind abrading particles to nickel of sufficient hardness.

BRIEF DESCRIPTION OF THE DRAWINGS

Figs. 1A - 1G are sequential processing diagrams
15 illustrative of the prior art wherein:

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Fig. 1A illustrates the beveled edge of a saw blade blank having zinc and copper plated thereon;

Fig. 1B illustrates the beveled edge of a saw blade blank having nickel embedded abrading particle layer plated over the copper;

Fig. 1C illustrates the beveled edge of a saw blade blank with the plated layers removed from the beveled side of the saw blade;

Fig. 1D illustrates the beveled edge of a saw blade blank having the end plated material removed;

Fig. 1E illustrates the beveled edge of a saw blade blank being machined away in preparation for the chemical removal of the remaining aluminum;

Fig. 1F illustrates the edge of a saw blade blank after removal of the thin machined layer of aluminum;

Fig. 1G illustrates the edge of a saw blade blank after removal of the copper layer overlying the nickel embedded abrading particle layer;

Fig. 2A is a sectional view across 2A - 2A of Fig.

1F illustrating protrusion of abrading particles from one side of the nickel embedded abrading particle layer with abrading particles on the opposite side being fully embedded with the nickel embedded abrading particle layer;

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Fig. 2B is a sectional view across 2B - 2B of Fig. 1G illustrating the prior art product after electro-polishing with the protrusion of abrading particles excessively from one side of the nickel embedded abrading particle layer with normal protrusion on the opposite side of the nickel embedded abrading particle layer;

Fig. 3A illustrates the improvement of this invention to the step previously illustrated in Fig. 1A with abrading particles shown being plated to the copper layer to embed the abrading particles within the resultant copper layer;

Fig. 3B is illustrates the plating of the nickel embedded abrading particle layer illustrating that abrading particles embedded within the previously plated copper layer extend across and into the interface between the copper layer and the nickel embedded abrading particle layer;

Fig. 4 is a side elevation cross-section of the embedded abrading particle hubbed saw blade of this invention;

Fig. 5 is a view taken along line 5 - 5 of Fig. 4 illustrating the state of abrading particles embedded within nickel embedded abrading particle layer after production of the saw blade to eliminate the need for electro-polishing;

Fig. 6 is a view taken along line 6 - 6 of Fig. 4 illustrating the telltale embedding of abrading particles across the copper nickel interface of the ultimately produced saw blade of this invention;

Fig. 7 is a perspective view of a prior art plating mandrel utilized in the chemical plating, etching, and electro-polishing steps illustrated in this specification;

Fig. 8 is a view of the saw blade blank to which the processing of this invention occurs;

Fig. 9 is an improved plating configuration of this invention here shown adapted to the plating of abrading particles with copper onto the mandrel mounted saw blade blanks of this invention, it being noted that a diaphragm pump circulates and suspends the abrading particles for embedding to the copper layer being plated within the illustrated tank;

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Fig. 10 is an improved plating tank similar to that illustrated in Fig. 9, the tank here being shown having a plating basket with a conical bottom for permitting efficient settling and redistribution by pumping of the abrading particles during the plating of the nickel;

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Fig. 11A is a plating basket of the prior art;
Fig. 11B is an improved plating basket of this
invention having a conical bottom for abrading particle
collection and illustrating a central band having numerous
apertures with plating occurring with central and uniform
electrical communication of the cathode and anode through the
holes within the band;

Fig. 12A illustrates a saw blade kerf of the prior art illustrating the cracking phenomena found along one edge of the saw blade kerf; and,

Fig. 12B illustrates a saw blade kerf as ideally left in the wake of the saw blade of this invention.

DESCRIPTION OF THE PREFERRED EMBODIMENT

Referring to Fig. 3A, the improvement in the process of this invention can be understood. As can be seen, circular aluminum saw blade hub 20 at beveled edge 22 has abrading particle embedded copper layer 26' plated over zinc layer 24. When abrading particle embedded copper layer 26' is plated, it will be seen that abrading particles 36 protrude from the surface of the copper layer.

Plating occurs utilizing the apparatus illustrated in Fig. 9. Cylindrical plating tank 50 includes circular titanium mesh anode 52 having so-called sacrificial anodes of the material to be plated (here either nickel or copper). Into and inside of circular titanium mesh anode 52 there is placed the plating baskets illustrated in Figs. 11A or 11B.

Referring to Fig. 11A, plating basket 55 is illustrated. Plating basket 55 is cylindrical in shape, includes closed bottom 54, open top 56 with central apertures 58 covered by mesh 57. Mesh 57 is sized to permit fluid and electrical communication into and out of plating basket 55 but to restrict abrading particles 36 to the interior of plating

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basket 55. For example, where the size of abrading particles 36 is between three (3) and five (5) mils, mesh 57 has a size smaller than the smallest of abrading particles 36.

Plating basket 55 is placed interiorly of circular titanium mesh anode 52 and allows electrical communication between a cathode placed within plating basket 55 and circular titanium mesh anode 52.

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Where plating is to occur, a plurality of saw blades S are mounted to mandrel M between upper mandrel plug 60 and lower mandrel plug 62. In between each saw blade S there is placed gaskets G. Gaskets G have the function of shielding the bulk of circular aluminum saw blade hub 20 while plating or other chemical processing occurs at the unshielded edge of beveled edge 22.

15 Returning to Fig. 9, the remainder of the assembly can now be understood. Specifically, diaphragm pump P is illustrated having suction line 64 communicated into the interior of plating basket 55. Diaphragm pump P at discharge line 66 communicates to the top of plating basket 55. controlling the timing and rate of pumping, abrading particles 20 36 within plating basket 55 are drawn from closed bottom 54 and kept in suspension during plating of abrading particle embedded copper layer 26'. I have found that by substituting liquid pumping for air entrainment of the prior art, a more 25 consistent and predictable suspension of abrading particles 36 results.

Plating of nickel embedded abrading particle layer 28 is accomplished by similar apparatus illustrated in Fig. 10. Cylindrical plating tank 50 here contains nickel plating solution. Circular titanium mesh anode 52 has plating basket 70 therein.

Plating basket 70 is illustrated in Fig. 11B and has conical bottom 71 to which suction line 64 is communicated adjacent the apex. Unlike the previously illustrated plating basket 55, plating basket 70 includes aperture band 72.

Aperture band 72 is cover from the inside of plating basket 70 with mesh 57.

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Diaphragm pump P draws a suction from suction line 64 and discharges abrading particles 36 in suspension through discharge line 66 into the open and upper end of plating basket 70. Plating occurs with a sufficient amount of abrading particles to cause embedding of the abrading particles within the plated layers and illustrated in Fig. 3B.

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It will be understood that I control the hardness of the ultimately produced nickel/cobalt alloy. Specifically, inorganic wetting agents and liquid hardeners are empirically varied to produce the harness desired. This enables both a hardness together with sufficient elasticity and porosity to hold the abrading particles in place for a long blade life. By way of example, utilizing a 2% cobalt alloy of the nickel, I have found that a hardness in the order of 420-550 Vickers produces a satisfactory saw blade product.

It will be understood that the combination of aperture band 72 combined with circular titanium mesh anode 52 produces a circularly even electrical field on mandrel M having saw blades S disposed for plating.

I have illustrated an electro-plating process in setting forth this invention. The reader will understand that other types of plating may be used as well. For example, so-called electrode-less plating may as well be used.

Returning to Figs. 4 and 6, the product of this invention may be illustrated. Specifically, and referring to Fig. 6, it will be seen that the fabricated nickel embedded abrading particle saw blade edge 80 is held to circular aluminum saw blade hub 20 by abrading particle embedded copper layer 26'. This is to be distinguished from copper layer 26. Further, it will be noted that it is characteristic of nickel embedded abrading particle saw blade edge 80 that it is held to circular aluminum saw blade hub 20 by abrading particle embedded copper layer 26' with abrading particles 36 extending across the interface between the copper and nickel. In this way, it is possible to uniquely recognize the saw blade of this invention over saw blades of the prior art.

WHAT IS CLAIMED IS:

1	1. A saw blade comprising in combination:
2	a circular aluminum blank for attaching to a saw
3	blade arbor at a central aperture and a circular periphery for
4	holding the saw blade;
5	a cutting rim having plated nickel embedded abrading
6	particles with abrading particles exposed on both sides of
7	said cutting rim;
8	a copper substrate fastened to the periphery of the
9	circular aluminum blank on one side, fastened to the periphery
10	of the cutting rim on the opposite side, said copper substrate
11	having deposited abrading particles extending across the
12	interface of the copper substrate with nickel embedded
13	abrading particles.

- A saw blade according to claim 1 and comprising
 in further combination:
- said cutting rim having plated nickel embedded

 abrading particles has both side surfaces produced without

 electro-polishing for exposure of abrading particless along
 one saw blade edge.
- 3. A saw blade according to claim 1 and comprising
 in further combination:
- the nickel of the cutting rim having plated nickel embedded abrading particles is a cobalt alloy.
- 4. A saw blade according to claim 1 and comprising in further combination:
- 3 the abrading particles are diamonds.
- 5. In a process of fabricating a cutting rim
 having plated nickel embedded abrading particles to circular
 aluminum saw blade hub having the steps of:
- plating zinc to the periphery of aluminum saw blade hub;

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plating copper to the zone on the periphery of the aluminum saw blade hub;

plating a nickel embedded abrading particles layer
over the copper;

removing the nickel embedded abrading particles
layer and the copper from the radial edge and one side of the
saw blade; and,

removing aluminum adjacent the remaining nickel embedded abrading particles layer; and,

removing copper over the nickel embedded abrading
particle layer to expose the abrading particles for cutting;
the improvement comprising:

the improvement comprising:

plating said copper with abrading particles imbedded

into the copper whereby when said nickel embedded abrading

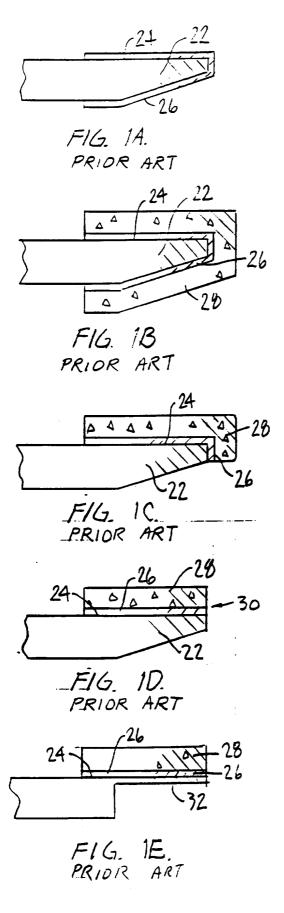
particle layer is plated, abrading particles extend across the

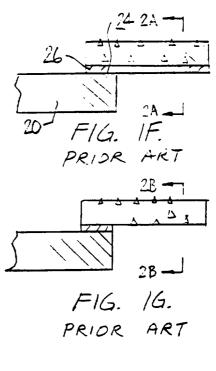
copper nickel interface.

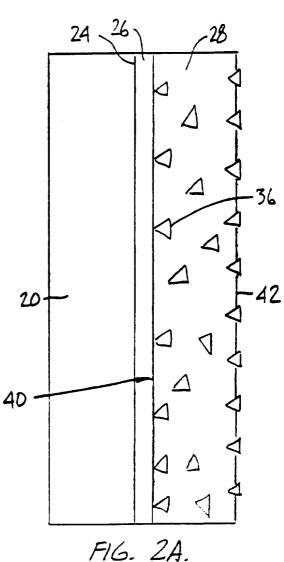
- 6. In a process of fabricating a cutting rim
 having plated nickel embedded abrading particles to circular
 aluminum saw blade hub according to claim 5 having the further
 steps of:
- 5 plating a nickel embedded abrading particle layer
 6 with a cobalt alloy of nickel.
- 7. In a process of fabricating a cutting rim
 having plated nickel embedded abrading particles to circular
 aluminum saw blade hub according to claim 5 having the further
 steps of:
- at least one of said plating steps includes mounting said saw blade to a central cathode;
- providing a cylindrical anode; and,
- plating to the central cathode utilizing the field
 from the cylindrical anode.
- 8. In a process of fabricating a cutting rim
 having plated nickel embedded abrading particles to circular
 aluminum saw blade hub according to claim 5 having the further
 steps of:

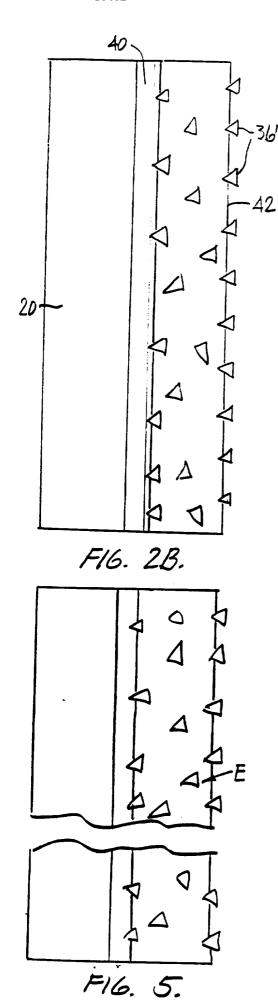
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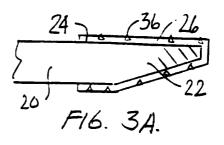
5 said plated abrading particles are diamonds. 1 In a process of fabricating a cutting rim 9. 2 having plated nickel embedded abrading particles to circular 3 aluminum saw blade hub according to claim 7 having the further 4 steps of: 5 providing a plating basket having an open top, a 6 closed bottom, and cylindrical side walls; 7 providing mesh covered apertures centrally of said 8 plating basket for communicating plating fluid and current; 9 placing saw blades to be plated centrally of the 10 plating basket; and, 11 mounting saw blades centrally of the plating basket 12 for plating from the anode to the cathode. 1 In a process of fabricating a cutting rim 10. 2 having plated nickel embedded abrading particles to circular aluminum saw blade hub according to claim 9 having the further 3 4 steps of: 5 providing a pump having an inlet and an outlet; 6 communicating the inlet of the pump to the bottom of the plating basket and the outlet of the pump adjacent the top 7 of the plating basket; and, 8 9 running said pump during plating to keep abrading 10 particles in suspension. 1 In a process of fabricating a cutting rim having plated nickel embedded abrading particles to circular 2 aluminum saw blade hub according to claim 10 having the 3 further steps of: 4 5 providing the plating basket with a conical bottom to collect abrading particles settling from the plating 6 7 solution; and, 8 communicating the inlet to said pump to the conical 9 apex of the plating basket to collect said abrading particles to the inlet of the pump. 10

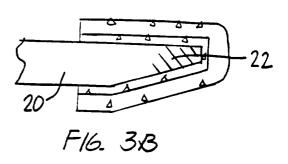


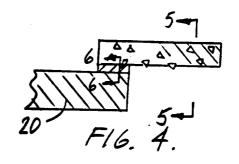


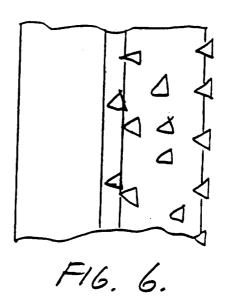


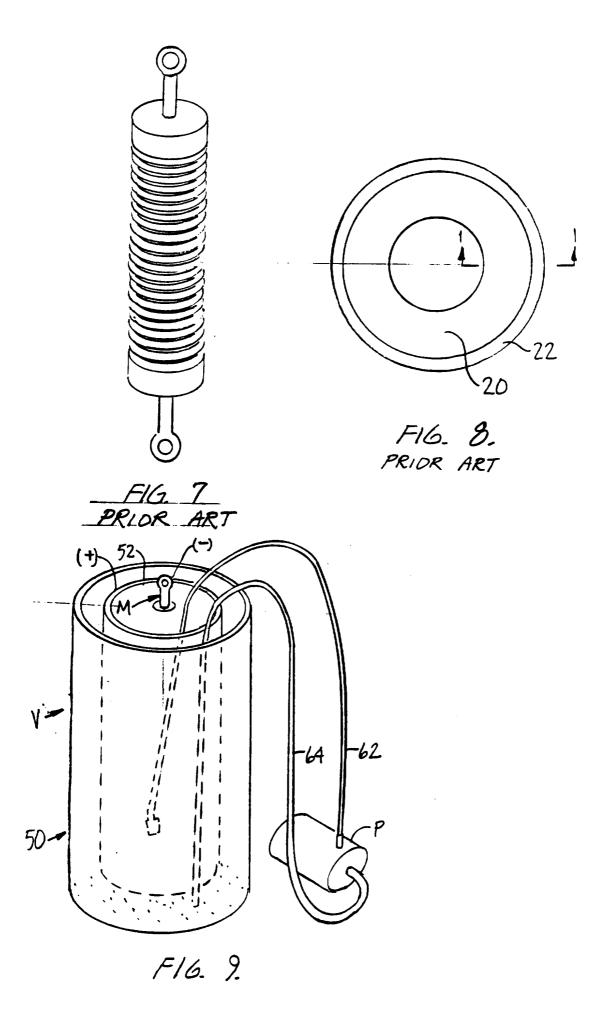


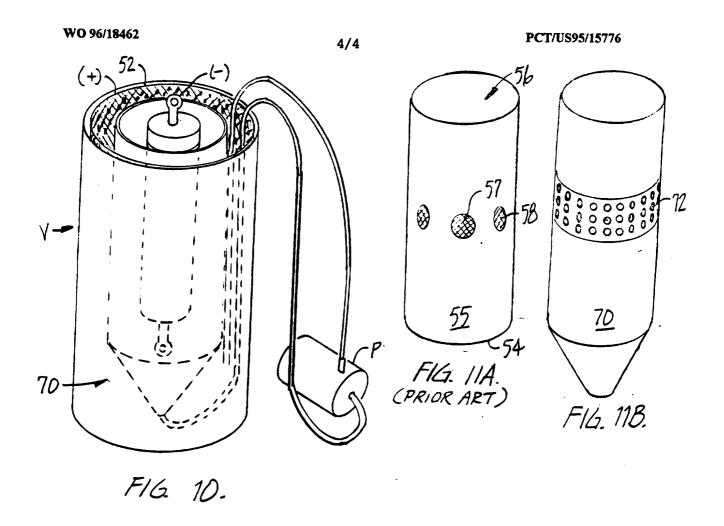


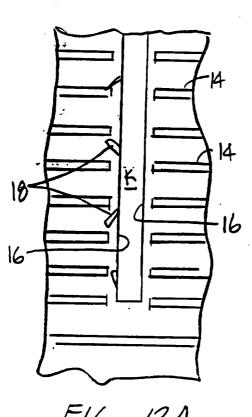


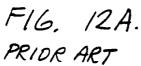


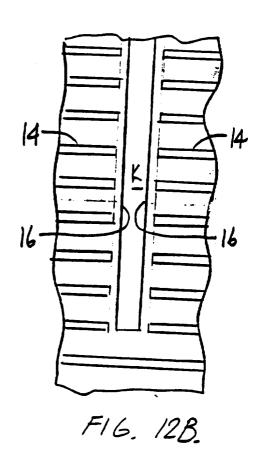












INTERNATIONAL SEARCH REPORT

International application No. PCT/US95/15776

A. CI	ASSIFICATION OF SUBJECT MATTER		
IPC(6)	:B05D 3/12; B28D 1/06		
US CL According	:125/15; 427/367, 404	a to the second	
B. FU	to International Patent Classification (IPC) or to ELDS SEARCHED	o both national classification and IPC	
	documentation searched (classification system for	Nound has already at	
U.S. ;	125/15, 18; 427/180, 212, 216, 289, 367, 404	-404	
Document	ation searched other than minimum documentation	to the extent that such documents are include	led in the fields searched
Electronio	data base consulted during the international scan	ch (name of data base and, where practical	de seemb terms up 1
		and and production	io, scaron terms used)
C. DOC	CUMENTS CONSIDERED TO BE RELEVAN	TY	/
Category*	Citation of document, with indication, whe	are appropriate, of the relevant passages	Relevant to claim
A	US, A, 3,092,094 (G. GRIFFIN	ET AL) 04 JUNE 1963	1-11
۸ .	US, A. 3,205,624 (S. WEISS)	14 SEPTEMBER 1965	1-11
•	US, A, 3,491,742 (S. WEISS)	27 JANUARY 1970	1-11
\	US, A, 3,553,905 (J. LEMELSC	N) 12, JANUARY 1971	1-11
	US, A, 4,180,048 (B. REGAN)	25 DECEMBER 1979	1-11
1			
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l			
Purther	documents are listed in the continuation of Box		
	al categories of gited documents:		
dacus	cent defining the general sints of the art which is not considered	fater document published after the letter date and not in conflict with the applica	tion but clied to male made also
#D 500	of particular relevance document published on or after the international filing does	principle or theory underlying the inve "X" document of perticular relevance; the	
dooun	sent which may throw doubts on neighbor claim(s) as which to	when the decrease to take a least	ed to involve an inventive step
shear	costablish the publication date of another citation or other reason (se specified)	document of perticular relevance; the	claimed invention cannot be
docum menn	eat referring to an oral disclosure, use, exhibition or other	considered to involve an inventive of combined with one or more other such being obvious to a person skilled in the	top when the decument is
docum	ont published prior to the interactional filling data but later than ority data claimed	.g., quorament memper of the same balent to	
	ual completion of the international search	Date of mailing of the international sear	•
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mmissioner (ing address of the ISA/US of Patents and Trademarks	Authorized officer	halfort mes
x PCT whington, D.	.c. 20231	Timothy V. Eley Part	legal Speciality
imile No.	(703) 305-3230	Telephone No. (703)308-1824	Froum 3200

INTERNATIONAL SEARCH REPORT

International application No. PCT/US95/15776

Box I Observations where certain claims were found unsearchable (Continuation of item 1 of first sheet)
This international report has not been established in respect of certain claims under Article 17(2)(a) for the following reasons:
Claims Nos.: because they relate to subject matter not required to be searched by this Authority, namely:
2. Claims Nos.: because they relate to parts of the international application that do not comply with the prescribed requirements to such an extent that no meaningful international search can be carried out, specifically:
Claims Nos.: because they are dependent claims and are not drafted in accordance with the second and third sentences of Rule 6.4(a).
Box II Observations where unity of invention is lacking (Continuation of item 2 of first sheet)
This International Searching Authority found multiple inventions in this international application, as follows:
Picase See Extra Sheet.
1. X As all required additional search fees were timely paid by the applicant, this international search report covers all searchable claims.
2. As all searchable claims could be searched without effort justifying an additional fee, this Authority did not invite payment of any additional fee.
3. As only some of the required additional search fees were timely paid by the applicant, this international search report covers only those claims for which fees were paid, specifically claims Nos.:
4. No required additional search fees were timely paid by the applicant. Consequently, this international search report is restricted to the invention first mentioned in the claims; it is covered by claims Nos.:
Remark on Protest
No protest accompanied the payment of additional search fees.

Form PCT/ISA/210 (continuation of first sheet(1))(July 1992)*

INTERNATIONAL SEARCH REPORT

International application No. PCT/US95/15776

BOX II. OBSÉRVATIONS WHERE UNITY OF INVENTION WAS LACKING This ISA found multiple inventions as follows:

This application contains the following inventions or groups of inventions which are not so linked as to form a single inventive concept under PCT Rule 13.1. In order for all inventions to be examined, the appropriate additional examination fees must be paid.

Group I, claims 1-5, drawn to a saw blade.

Group II, claims 5-11, drawn to a process of fabricating a cutting rim.

The inventions listed as Groups I and II do not relate to a single inventive concept under PCT Rule 13.1 because, under PCT Rule 13.2, they lack the same or corresponding special technical features for the following reasons:

Group I has the special technical feature of a cutting rim having plated nickel embedded abrading particles with abrading particles exposed on both sides of the cutting rim.

Group II has the special technical feature of plating zinc to the periphery of an aluminum saw blade.

Group I does not require the special technical feature of Group II.